

型号 model	*拆分部位名称 Disassembly Unit/component description (e.g. Resistor、Capacitor、Inductor、homogeneous Material of cable and Mechanical Part)	*均质材料名称 Homogeneous Material Name. (e.g. Aluminum alloy)	物质名称 Substance Name (e.g. Copper (Cu))	*CAS No.	*物质重量 Substance Mass. (mg)	Content Rate(%) (均质材料中的含量 per homogeneous materials)
TPS22976D PU	Bond Wire	Aluminum and Its Alloys	Aluminum	7429-90-5	0.000001	0.000348
		Copper and Its Alloys	Copper	7440-50-8	0.287738	99.99514
		Copper and Its Alloys	Iron	7439-89-6	0.000001	0.000348
		Not Categorized	Proprietary Materials		0.000001	0.000348
		Other Inorganic Materials	Sulfur	7704-34-9	0.000001	0.000348
		Other Nonferrous Metals and Alloys	Calcium	7440-70-2	0.000006	0.002085
		Precious Metals	Silver	7440-22-4	0.000004	0.00139
	Die Attach Adhesive	Precious Metals	Silver	7440-22-4	0.186568	81.09995
		Thermoplastics	Epoxy	85954-11-6	0.043479	18.90005
	Lead Frame	Copper and Its Alloys	Copper	7440-50-8	7.857623	99.24999
		Other Nonferrous	Chromium	7440-47-3	0.020584	0.259997

		Metals and Alloys				
		Other Nonferrous Metals and Alloys	Tin	7440-31-5	0.019793	0.250006
		Zinc and Its Alloys	Zinc	7440-66-6	0.019001	0.240002
	Lead Frame Plating	Nickel and Its Alloys	Nickel	7440-02-0	0.136022	95.12028
		Precious Metals	Gold	7440-57-5	0.001115	0.77972
		Precious Metals	Palladium	7440-05-3	0.005863	4.1
	Mold Compound	Other Inorganic Materials	Fused Silica	60676-86-0	5.559788	90.5
		Other Plastics and Rubber	Carbon Black	1333-86-4	0.030717	0.499999
		Thermoplastics	Epoxy	85954-11-6	0.552907	8.999999
	Semiconductor or Device	Ceramics / Glass	Doped Silicon	7440-21-3	0.496576	100